

PSM20N65CT

PFC Device Corporation

20A 650V Single N-Channel Power MOSFET

Major ratings and characteristics

Characteristics	Values	Units
V _{DS} @T _J max	650	V
R _{DS(ON)} , V _{GS} =10V	0.19	Ω
I _D	20	Α

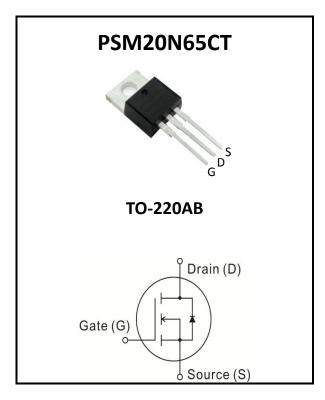
General Description

PFC MLSJ (Multi-Layer Super Junction)
MOSFET technology is the ideal choice for
the PFC and PWM application. PFC device
provides practical advantages of higher
pressure-resistance, lower on-resistance to
achieve the ideal balance between the
switching speed and on-resistance.

Typical Applications

PFC stages, hard switching PWM stages and resonant switching stages for PC, Adapter, LCD & PDP TV, Lighting, Server, Telecom and UPS.

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.



Features

- Advanced High Voltage Technology
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Extreme dv/dt rated
- Lead Free Finish, RoHS Compliant

1. Characteristics

Maximum Ratings Characteristics

($T_A = 25$ °C unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DSS}	Drain-Source Voltage	650	V
	Drain Current – Continuous (T _C =25°C)	20	Α
I _D	Drain Current – Continuous (T _C =100°C)	13	Α
I _{D pulsed}	Pulsed Drain Current tp limited by T _J max (Note 1)	60	А
E _{AS}	Single Pulse Avalanche Energy (Noted 2)	300	mJ
E _{AR}	Avalanche Energy, repetitive t_{AR} limited by T_{imax} (Note 3) $I_D=20A,\ V_{DD}=50V$	1	mJ
I _{AR}	Avalanche Current, repetitive t _{AR} limited by T _{imax}	20	Α
V_{GS}	Gate-Source Voltage Static	±20	V
V_{GS}	Gate-Source Voltage AC (f>1Hz)	±30	V
P _{tot}	Power Dissipation	204	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	T _J Operating Junction Temperature Range		°C
dv/dt	dv/dt Peak Diode Recovery dv/dt (Note 4)		V/nS
dv/dt	` '		V/nS

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient		62	°C/W
$R_{ heta JC}$	Thermal Resistance Junction to case (Drain)		0.61	°C/W



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Electrical Characteristics

(T_J = 25 °C unless otherwise specified)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	650			٧
	Drain Course Leakers Current	V _{DS} =600V, V _{GS} =0V, T _J =25°C	0.05	0.05	1	uA
I _{DSS}	Drain-Source Leakage Current	V _{DS} =600V, V _{GS} =0V, T _J =150°C			100	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±30V, V _{DS} =0V			±100	nA

On Characteristics

R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =13A, T _J =25°C		0.165	0.190	Ω	
IN _E	OS(ON)		V _{GS} =10V, I _D =13A, T _J =150°C		0.45		Ω
V	GS(th)	Gate-Source Threshold Voltage	$V_{GS}=V_{DS}$, $I_{D}=1000uA$	2.8	3.2	3.9	V
	R_G	Gate input resistance	f=1MHz, open Drain		0.54	-	Ω

Dynamic and switching Characteristics

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Q_gs	Gate-Source Charge	V _{DD} =480V, I _D =20A,	 13		
Q_{qd}	Gate-Drain Charge		 33		nC
Q_{g}	Gate charge total	V _{GS} =0 to 10V	 75	110	
V _(plateau)	Gate plateau voltage		 5.9		V
g fs	Transecondtance	$V_{DS} \ge 2*I_D*R_{DS(on)max}, I_D=13A$	 20.5		S
$T_{d(on)}$	Turn-On Delay Time	V _{DD} =380V, V _{GS} =0/13V, I _D =20A,	 8		
T _r	Rise Time		 34		nS
$T_{d(off)}$	Turn-Off Delay Time	$R_g=3.6\Omega$, $T_J=25^{\circ}C$	 42		113
T_f	Fall Time		 58		
C_{iss}	Input Capacitance		 2400		
C _{oss}	Output Capacitance	V _{GS} =0V, V _{DS} =100V -f=1 MHz	 81		pF
C_{rss}	Reverse Transfer Capacitance	1-1 1711 12	 32		

Drain-Source Diode Characteristics and Maximum ratings

V_{SD}	Inverse diode forward voltage	I _S = 20A, V _{GS} = 0V	 0.91	1.2	V
t _{rr}	Reverse Recovery Time		 491	800	nS
Q_{rr}	Reverse Recovery Charge	V _R =480V, I _F =I _S , di _F /dt=100A/uS	 10		uC
I _{rrm}	Peak reverse recovery current	Tuif/ui=100A/uS	 42		Α

Note:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. V_{DD} =50V, I_D =10A, Starting T_J =25°C.
- 3. Repetitive avalanche cause additional power lose that can be calculated as $P_{AV} = E_{AR}^*f$.
- 4. $I_{SD} \le I_D$, di/dt ≤ 400 A/us, $T_J < T_J$, max



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2. Characteristics Curves

Ratings and Characteristics Curves

($T_A = 25^{\circ}C$ unless otherwise specified)

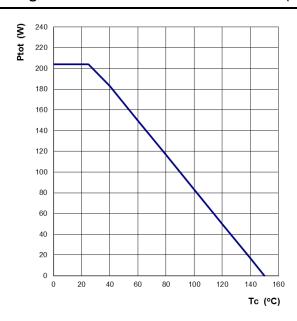


Figure 1: Power Dissipation
Ptot = f (T_C)

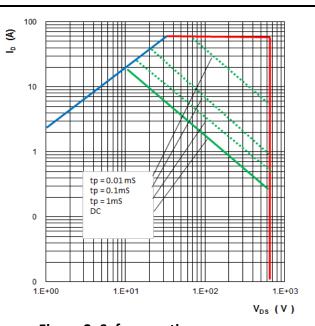


Figure 2: Safe operating area $I_D = f(V_{DS})$ parameter : D = 0, T_C =25°C

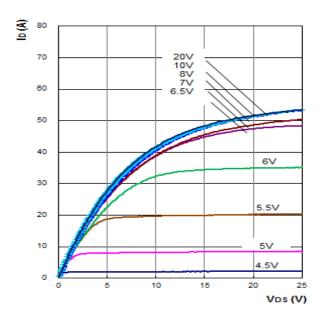


Figure 3: Typ. Output Characteristics $I_D = f(V_{DS})$; $T_J = 25^{\circ}C$ parameter : $t_p = 100uS$, V_{GS}

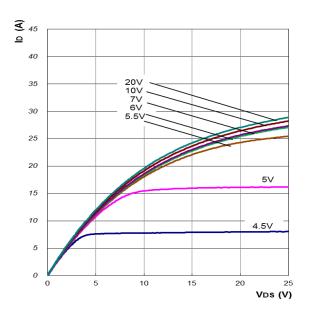


Figure 4: Typ. Output Characteristics $I_D = f(V_{DS})$; $T_J = 150^{\circ}C$ parameter : $t_p = 100uS$, V_{GS}



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Ratings and Characteristics Curves

($T_A = 25^{\circ}C$ unless otherwise specified)

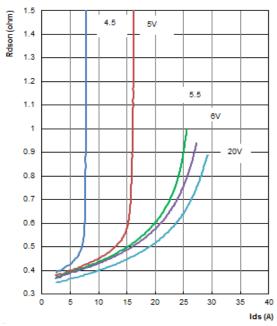


Figure 5: Typ. Drain Source On-Resistance $R_{DS}(on)=f(I_D)$ parameter : $t_p=100uS$, $T_J=150^{\circ}C$, V_{GS}

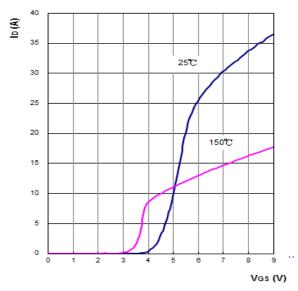


Figure 7: Typ. Transfer Characteristics $I_D = f(V_{GS}); V_{DS} \ge 2 X I_D X R_{DS}(on) max$ parameter : t_p =100 uS

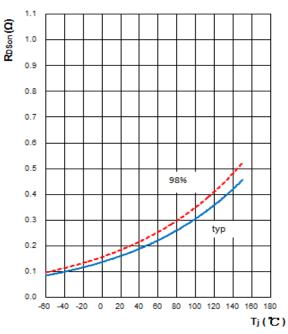
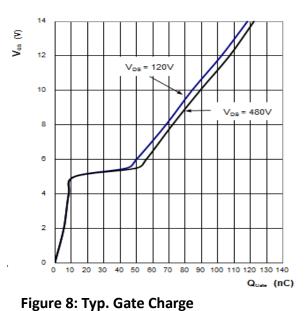


Figure 6: Drain-Source On-state Resistance $R_{DS}(on) = f(T_J)$ parameter : $I_D = 13A$, $V_{GS} = 10V$



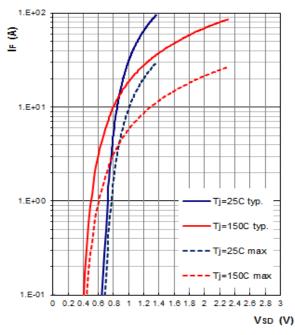
 $V_{GS} = f(Q_{GATE})$ parameter: $I_D=20A$ pulsed



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Ratings and Characteristics Curves

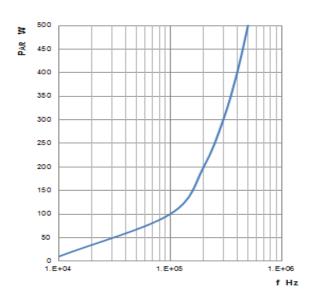
($T_A = 25^{\circ}C$ unless otherwise specified)



780
760
740
720
700
680
660
640
620
600
580
560
540
-60 -20 20 60 100 140 180
Tj (°C)

Figure 9: Forward characteristics of body diode $I_F = f(V_{SD})$ parameter : T_J , t_p =100uS

Figure 10: Drain-source breakdown voltage $V_{(BR)DSS} = f(T_J)$



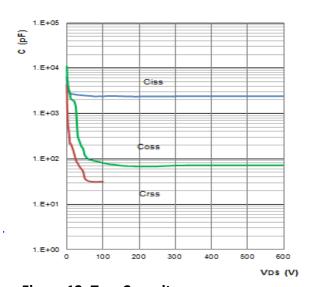


Figure 11: Avalanche power losses $P_{AR} = f(f)$ parameter : E_{AR}=1mJ

Figure 12: Typ. Capacitances $C = f(V_{DS})$ parameter : V_{GS} =0V, f=1MHz



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Ratings and Characteristics Curves

($T_A = 25^{\circ}C$ unless otherwise specified)

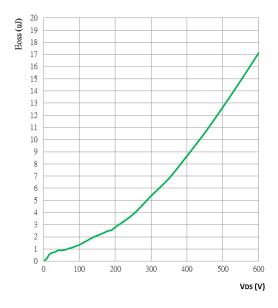


Figure 13: Typ. C_{oss} stored energy E_{oss} =f (V_{DS})



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3. Test Circuits and Waveforms

Test Circuits and Waveforms

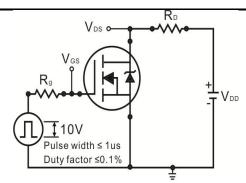


Figure 1: Switching times test circuit

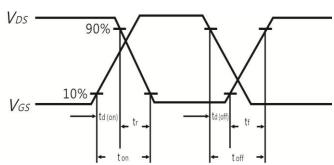


Figure 2: Switching time waveform

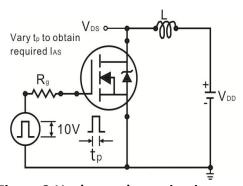


Figure 3:Unclamped test circuit

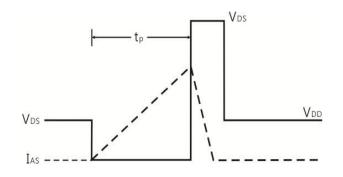


Figure 4: Unclamped test waveform

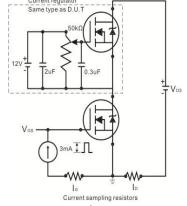


Figure 5:Gate charge test circuit

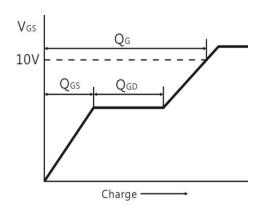


Figure 6: Basic gate charge waveform



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4. Marking information

Top Marking Rule

PFC PSM 20N65CT YYWW ABSH PSM20N65CT = Product Type Marking Code

YY = Last two digits of year

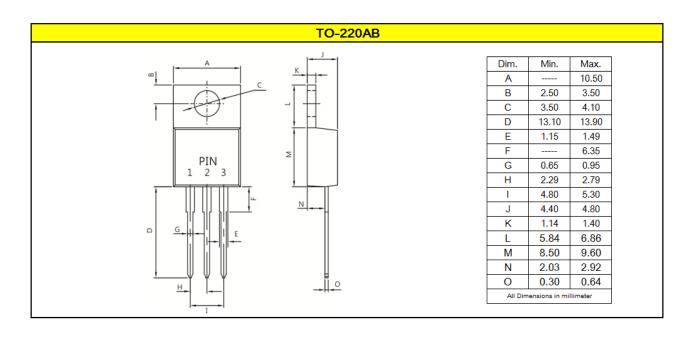
WW = Week code

ABS = Assembly code

H = Halogen Free (N/A = common molding compound)

5. Package information

Package Outline Dimensions millimeters





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6. Ordering information

Part Number	Package	Delivery mode
PSM20N65CT	TO-220AB	50 pieces / tube

Note: For Halogen Free molding compound, add "H" suffix to part number above.

Mechanical

Molder Plastic: UL Flammability Classification Rating 94V-0

■ Device Weight: 0.07 ounces (1.96grams) — TO-220AB

■ Mounting Torque: Recommended 10 in-lbs maximum

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